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SPECIFICATION

PART NO. : LT5K63-AB-RGB-SJN

3.2 x 2.8mm SMD TYPE



Approved by

Checked by

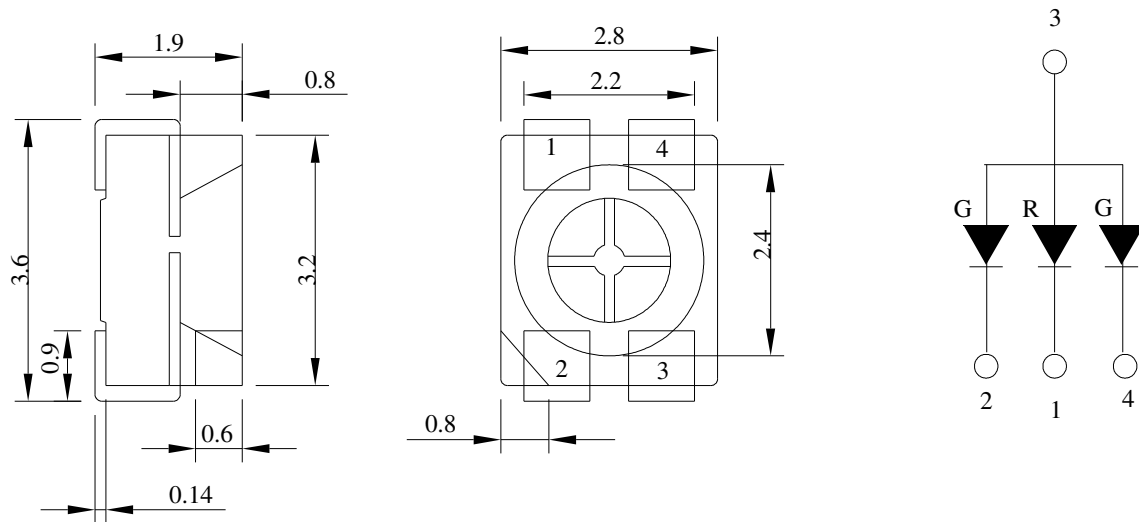
Prepared by

Tung

Lian

Yuan

Package Dimensions



Notes:

- 1. All dimensions are in mm.
- 2. Tolerance is ± 0.25 mm unless otherwise noted.

Description

Part No.	LED Chip		Lens Color
	Material	Emitting Color	
LT5K63-AB-RGB-SJN	AlGaInP/GaAs	Hyper Red	Water Clear
	InGaN/Sapphire	True Green	
	InGaN/Sapphire	Blue	

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Unit
Power Dissipation	P _d	72	mW
Reverse Voltage	V _r	5	V
D.C. Forward Current	I _f	30	mA
Peak Current(1/10Duty Cycle,0.1ms Pulse Width.)	I _f (Peak)	100	mA
Operating Temperature Range	Topr.	-40 to +100	°C
Storage Temperature Range	Tstg.	-40 to +100	°C
Soldering Temperature	Tsld.	Reflow Soldering: 260°C for 10 sec. Hand Soldering: 350°C for 3 sec.	

Electrical and Optical Characteristics:**Hyper Red**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Luminous Intensity	I _v	I _f =20mA	110	220		mcd
Forward Voltage	V _f	I _f =20mA		1.9	2.4	V
Peak Wavelength	λ _p	I _f =20mA		632		nm
Dominant Wavelength	λ _d	I _f =20mA		625		nm
Reverse Current	I _r	V _r =5V			100	μA
Viewing Angle	2θ 1/2	I _f =20mA		120		deg
Spectrum Line Halfwidth	Δλ	I _f =20mA		20		nm

Notes: 1.The datas tested by IS tester.

2. Customer's special requirements are also welcome.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Unit
Power Dissipation	P _d	120	mW
Reverse Voltage	V _r	5	V
D.C. Forward Current	I _f	30	mA
Peak Current(1/10Duty Cycle,0.1ms Pulse Width.)	I _f (Peak)	100	mA
Operating Temperature Range	T _{opr.}	-40 to +100	°C
Storage Temperature Range	T _{stg.}	-40 to +100	°C
Soldering Temperature	T _{sld.}	Reflow Soldering: 260°C for 10 sec. Hand Soldering: 350°C for 3 sec.	
Electric Static Discharge Threshold (HBM)	ESD	300	V

Electrical and Optical Characteristics:

True Green

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Luminous Intensity	I _v	I _f =20mA	370	710		mcd
Forward Voltage	V _f	I _f =20mA		3.2	4.0	V
Peak Wavelength	λ _p	I _f =20mA		---		nm
Dominant Wavelength	λ _d	I _f =20mA		520		nm
Reverse Current	I _r	V _r =5V			50	μA
Viewing Angle	2θ 1/2	I _f =20mA		120		deg
Spectrum Line Halfwidth	Δλ	I _f =20mA		35		nm

Notes: 1. The datas tested by IS tester.

2. Customer's special requirements are also welcome.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Unit
Power Dissipation	P _d	120	mW
Reverse Voltage	V _r	5	V
D.C. Forward Current	I _f	30	mA
Peak Current(1/10Duty Cycle Pulse Width.)	I _f (Peak)	100	mA
Operating Temperature Range	T _{opr.}	-40 to +100	°C
Storage Temperature Range	T _{stg.}	-40 to +100	°C
Soldering Temperature	T _{sld.}	Reflow Soldering: 260°C for 10 sec. Hand Soldering: 350°C for 3 sec.	
Electric Static Discharge Threshold (HBM)	ESD	300	V

Electrical and Optical Characteristic

Blue

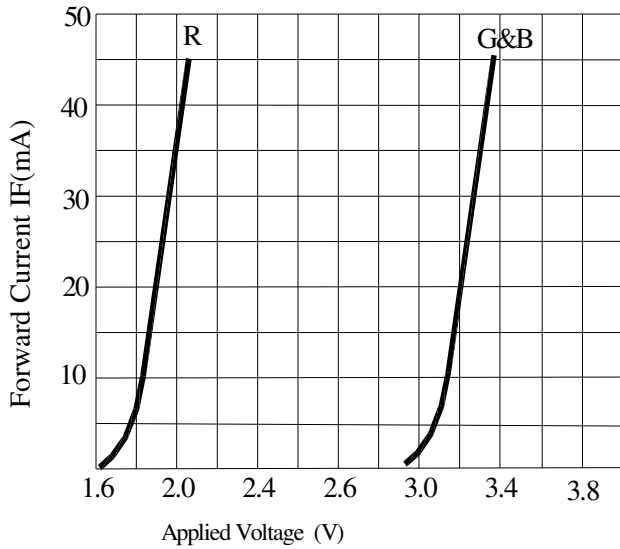
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Luminous Intensity	I _v	I _f =20mA	110	230		mcd
Forward Voltage	V _f	I _f =20mA		3.2	4.0	V
Peak Wavelength	λ _p	I _f =20mA		----		nm
Dominant Wavelength	λ _d	I _f =20mA		465		nm
Reverse Current	I _r	V _r =5V			50	μA
Viewing Angle	2θ 1/2	I _f =20mA		120		deg
Spectrum Line Halfwidth	Δλ	I _f =20mA		26		nm

Notes: 1. The datas tested by IS tester.

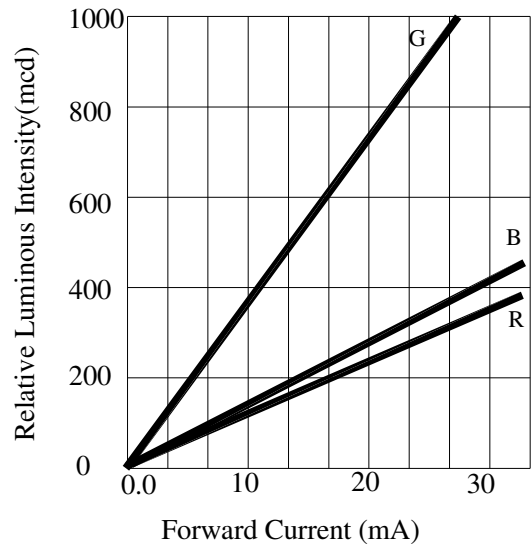
2. Customer's special requirements are also welcome.

Typical Electrical/Optical Characteristic Curves

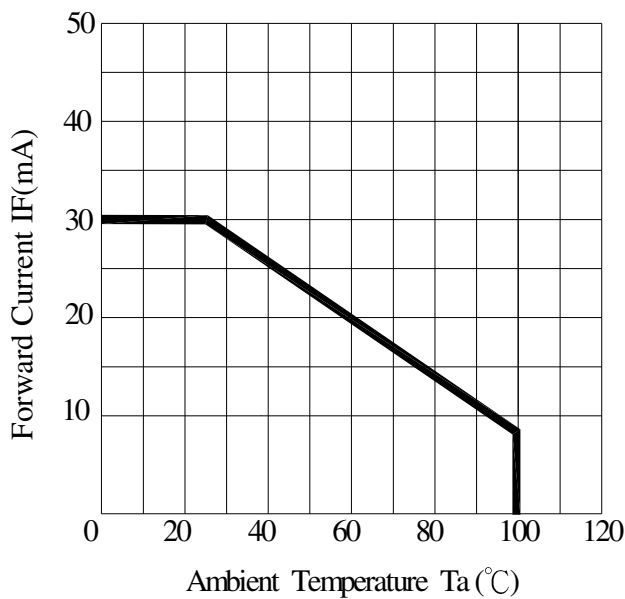
(25°C Ambient Temperature Unless Otherwise Noted)



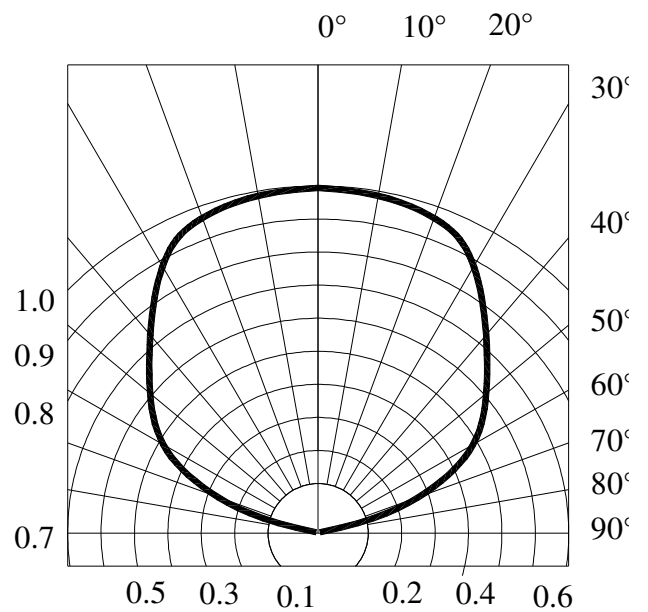
Forward Current VS. Applied Voltage



Forward Current VS. Luminous Intensity



Ambient Temperature VS. Forward Current



Radiation Diagram

PRECAUTION IN USE

Storage

Recommended storage environment

Temperature: 5°C ~ 30°C (41°F ~ 86°F)

Humidity: 60% RH Max.

Use within 7 days after opening of sealed vapor/ESD barrier bags.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

Fold the opened bag firmly and keep in dry environment.

Soldering

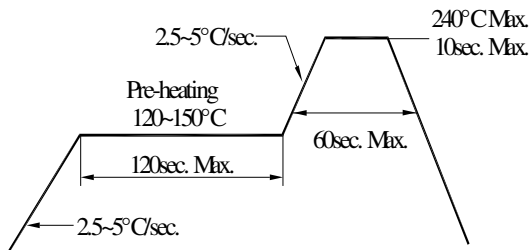
	Reflow Soldering		Hand Soldering	
	Lead Solder	Lead - free Solder		
Pre-heat	120~150°C	180~200°C	Temperature	350°C Max.
Pre-heat time	120sec. Max.	120sec. Max.	Soldering time	3sec. Max. (one time only)
Peak temperature	240°C Max.	260°C Max.		
Soldering time	10sec. Max.	10sec. Max.		
Condition	refer to Temperature- profile 1	refer to Temperature- profile 2		

*After reflow soldering rapid cooling should be avoided.

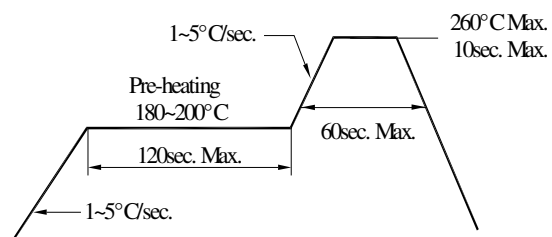
[Temperature-profile (Surface of circuit board)]

Use the conditions shown to the under figure.

< 1 : Lead Solder >

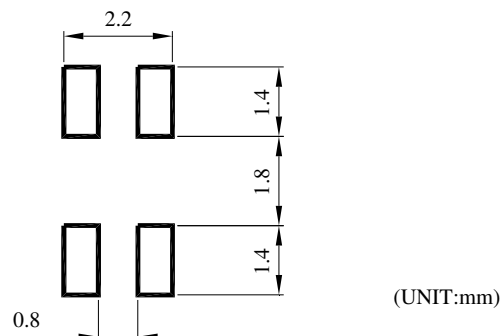


< 2 : Lead-free Solder >



[Recommended soldering pad design]

Use the following conditions shown in the figure.



Handling of Silicone Resin LEDs

Handling Indications

During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound

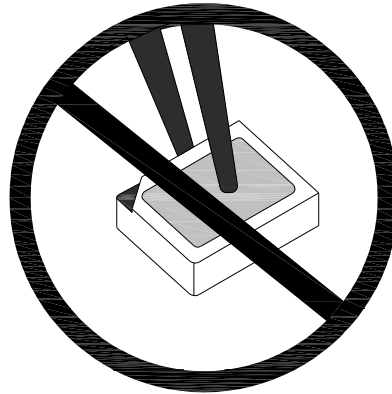


Figure 1

In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.

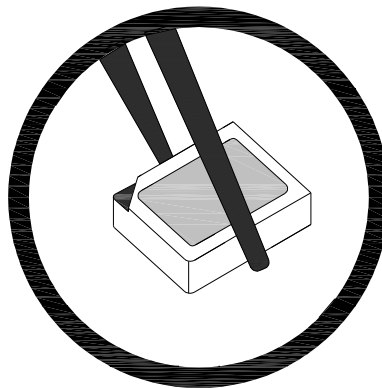
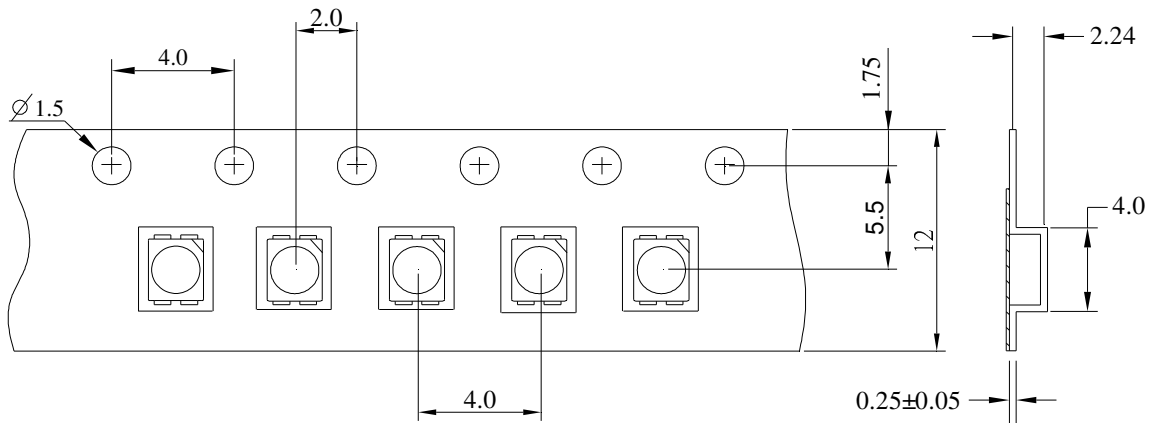


Figure 2

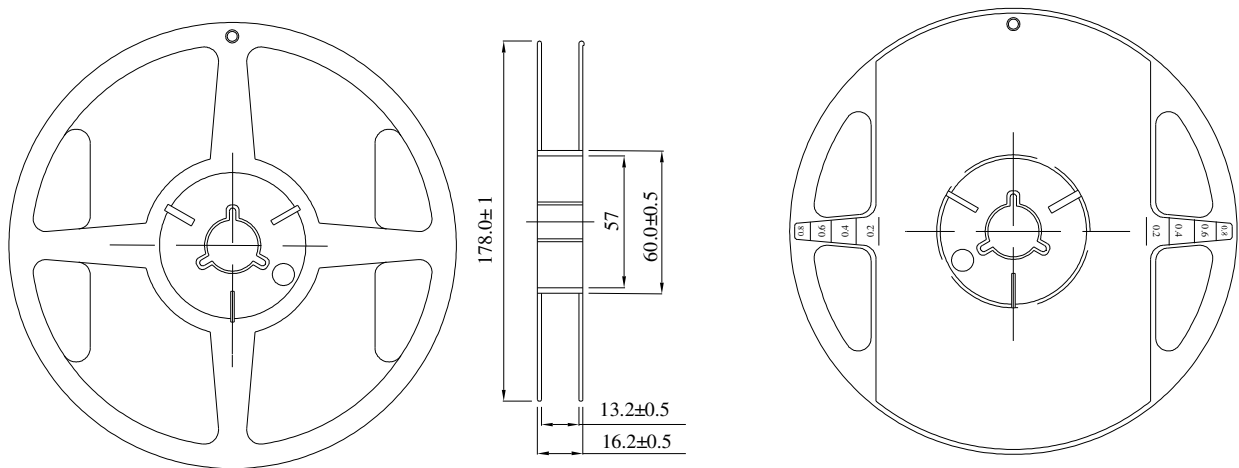
When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented.

This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.

Dimensions for Tape



Dimensions for Reel



Notes:

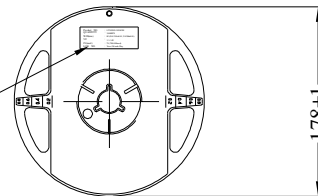
- 1.All dimensions are in mm, tolerance is ± 2.0 mm unless otherwise noted.
- 2.Specifications are subject to change without notice.

Packing

REEL

QUANTITY: 2,000 PCS

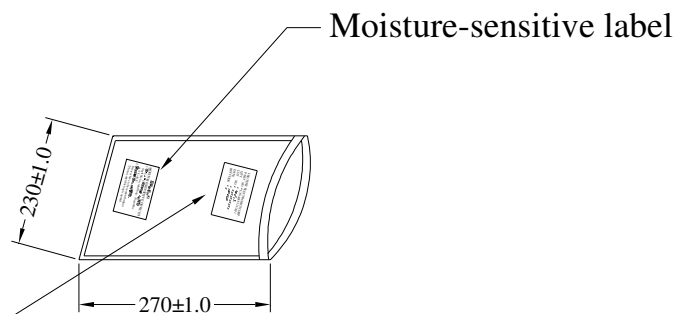
LEDTECH ELECTRONICS CORP.
PART NO :LTXXXX-XX
QTY : PCS
LOT NO :XXXXXXXXXX
DATE :
BIN CODE:



BAG

QUANTITY: 2,000 PCS

LEDTECH ELECTRONICS CORP.
PART NO :LTXXXX-XX
QTY : PCS
LOT NO :XXXXXXXXXX
DATE :
BIN CODE:

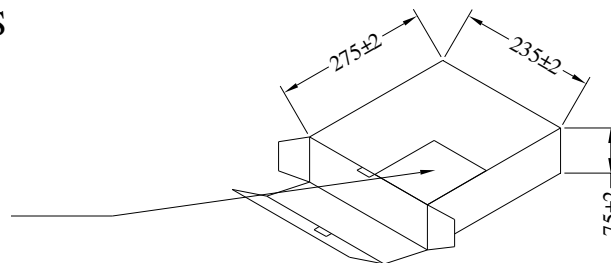


INSIDE BOX

QUANTITY: 4 BAGS

TOTAL: 8,000 PCS

LEDTECH ELECTRONICS CORP.
PART NO :LTXXXX-XX
QTY : PCS
LOT NO :XXXXXXXXXX
DATE :
BIN CODE:



Notes:

- 1.All dimensions are in mm, tolerance is ± 2.0 mm unless otherwise noted.
- 2.Specifications are subject to change without notice.